



#10/A Gp #2826
2/3/03
Muller

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:)
AMMAR)
Serial No. 09/863,030) Examiner: J. Mondt
Filing Date: May 22, 2001)
Confirmation No. 7280)
For: THICK FILM MILLIMETER WAVE) Art Unit: 2826
TRANSCIEVER MODULE)

RECEIVED
JAN 29 2003
TECHNOLOGY CENTER 2800

AMENDMENT

Director, U.S. Patent and Trademark Office
Washington, DC 20231

Sir:

Responsive to the Official Action of October 24,
2002, please enter the amendments and remarks set out below.

In the Claims:

Please amend Claims 1, 10, 16 and 26 as follows:

A¹

1. (ONCE AMENDED) A thick film millimeter wave
transceiver module comprising:
base plate;
a multi-layer, thick film substrate board, formed
from a plurality of layers of low temperature co-fired ceramic
material and received on said base plate and MMIC chips
directly attached to the substrate board, said layers
comprising at least one of